3/28/05

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address of receiving party(ies):
Name: MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD.
Address: 1006, Oaza Kadoma,
Kadoma-shi,
Osaka, 571-8501 JAPAN $\emptyset $
(1)
<u> </u>
Additional name(s) & address(es) attached? Yes No
execution date of the application is: March 22, 2005
B. Patent No(s).
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ched? Yes No
6. Total number of applications and patents involved:
7. Total fee (37 CFR 3.41) \$40.00
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nation I true and correct and any attached copy is a true copy
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$\ell \wedge$
March 25, 2005
Signature Date
otal number of pages including cover sheet: 3

PATENT REEL: 016422 FRAME: 0695

Attorney Docket No) .

ASSIGNMENT

	W	HEREAS,	Hideo NAKAGAWA, Masaru SASAGO and Yoshihiko HIRAI		
(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements					
in METHOD FOR FORMING SEMICONDUCTOR DEVICE					
		· · · · · · · · · · · · · · · · · · ·			
			for which the undersigned has	(have):	
	(a) filed an application for Letters Patent of the United States of America on				
			having Serial No;	or	
	(b)	executed a indicated b	n application for Letters Patent of the United States of America on the elow; and	ie date(s)	
WHEREAS,		HEREAS, _	Matsushita Electric Industrial Co., Ltd.	of	
1006, C			Kadoma-shi, Osaka 571-8501, Japan		
desirou	s of	acquiring th	gal representatives and assigns (hereinafter designated as the Assignee) is the entire right, title and interest in and to said invention and in and to any		
Patent(s	s) th	at may be gi	ranted therefor in the United States of America;		

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto the Assignee the full and exclusive right to the said invention in the United States of America and its territories and for all foreign countries, dependencies and possessions and the entire right, title and interest in and to the application and any and all Letters Patent(s) which may be granted therefor in the United States of America and its territories, dependencies and possessions, and in and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or any continuation, division or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims under or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

PATENT REEL: 016422 FRAME: 0696 The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to the Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the Assignee, as Assignee of the entire interest, and hereby convenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

This Assignment has been executed by the undersigned on the date(s) indicated.

Date: March 22, 2005,	Hideo Nakagawa Hideo NAKAGAWA
Date: March 22, 2005,	Masaru Sasago Masaru SASAGO
	Yoshihiko HIRAI
Date:,	

RECORDED: 03/28/2005

PATENT REEL: 016422 FRAME: 0697